Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under botter than the conversion of the					nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1	.1 IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x				Form Type Distribute											
Supplier	Informa	tion														
Company	Company name*			Company unique ID				Unique ID Authority					Response Date*			
onsemi											2024-0	2024-05-01				
Contact N	ame			Title - Contac	Title - Contact			Phone - Contact*				Email - Contact*				
Product-E	Env-Stewar	ds		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized	d Represent	tative*		Title - Representative				Phone - Representative*				Email - Representative*				
Product-E	Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date	Version	Manufacturing Site	Manufacturing Site		UOM	Unit Type			
	FODM88			801A 4SO HI-T TR				2024-05-01		LITEONFG	LITEONFG		mg	Each		
Manufacturing Process Information																
Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MSI			L Rating	g Peak Process Body Temperature Max Time at Pea			ak Temperature Number of Reflow Cycles						
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1			245	245 C 30		seconds 3							
Comments																
level 1 - maximum time at peak temperature during soldering is 10-30 seconds																
For more information regarding material composition please refer to page 3																

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others, not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier near not of the dentified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.267	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.0864	mg
			Supplier	Silicon (Si)	7440-21-3		0.1754	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0052	mg
Die Attach	0.25	mg	Supplier	Silver (Ag)	7440-22-4		0.205	mg
			Supplier	Dicyandiamine	461-58-5		0.0025	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0425	mg
Lead Frame	24.951	mg	Supplier	Silver (Ag)	7440-22-4		1.28	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0449	mg
			Supplier	Iron (Fe)	7439-89-6		0.6138	mg
			Supplier	Copper (Cu)	7440-50-8		22.9774	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0349	mg
Mold Compound-White	45.0	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		11.25	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		1.35	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.075	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		1.35	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		22.5	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.475	mg
Plating	0.239	mg	Supplier	Palladium (Pd)	7440-05-3		0.0095	mg
			В	Nickel (Ni)	7440-02-0		0.2238	mg
			Supplier	Gold (Au)	7440-57-5		0.0057	mg
Protective Coating	3.4	mg	Supplier	Poly(dimethylsiloxane), hydroxy terminated	70131-67-8		1.7	mg
			Supplier	Ethylbenzene	100-41-4		0.34	mg
			Supplier	Filler (SiO2)	68909-20-6		0.646	mg
			Supplier	Misc.	Proprietary Data		0.034	mg
			Supplier	Xylene	1330-20-7		0.68	mg
Wire Bond - Au	0.16	mg	Supplier	Gold (Au)	7440-57-5		0.16	mg